

# Schottky Diode

**V<sub>RRM</sub>** = 200 V  
**I<sub>FAV</sub>** = 2x 35 A  
**V<sub>F</sub>** = 0.79 V

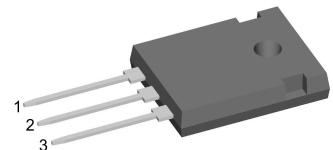
High Performance Schottky Diode

Low Loss and Soft Recovery

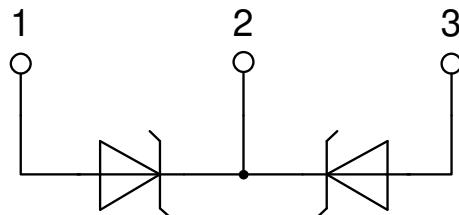
Common Cathode

**Part number**

**DSA70C200HB**



Backside: cathode



**Features / Advantages:**

- Very low V<sub>f</sub>
- Extremely low switching losses
- Low I<sub>rm</sub> values
- Improved thermal behaviour
- High reliability circuit operation
- Low voltage peaks for reduced protection circuits
- Low noise switching

**Applications:**

- Rectifiers in switch mode power supplies (SMPS)
- Free wheeling diode in low voltage converters

**Package:** TO-247

- Industry standard outline
- RoHS compliant
- Epoxy meets UL 94V-0

**Disclaimer Notice**

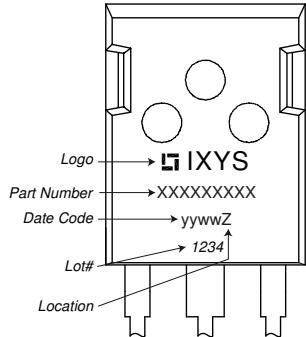
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**Schottky**

<b>Symbol</b>	<b>Definition</b>	<b>Conditions</b>	<b>Ratings</b>		
			<b>min.</b>	<b>typ.</b>	<b>max.</b>
<b>V<sub>RSM</sub></b>	max. non-repetitive reverse blocking voltage	T <sub>VJ</sub> = 25°C			200
<b>V<sub>RRM</sub></b>	max. repetitive reverse blocking voltage	T <sub>VJ</sub> = 25°C			200
<b>I<sub>R</sub></b>	reverse current, drain current	V <sub>R</sub> = 200 V V <sub>R</sub> = 200 V	T <sub>VJ</sub> = 25°C T <sub>VJ</sub> = 125°C		640 μA 7 mA
<b>V<sub>F</sub></b>	forward voltage drop	I <sub>F</sub> = 35 A I <sub>F</sub> = 70 A	T <sub>VJ</sub> = 25°C		0.93 V 1.07 V
		I <sub>F</sub> = 35 A I <sub>F</sub> = 70 A	T <sub>VJ</sub> = 125°C		0.79 V 0.95 V
<b>I<sub>FAV</sub></b>	average forward current	T <sub>C</sub> = 150°C rectangular d = 0.5	T <sub>VJ</sub> = 175°C		35 A
<b>V<sub>F0</sub></b> <b>r<sub>F</sub></b>	threshold voltage } slope resistance } for power loss calculation only		T <sub>VJ</sub> = 175°C		0.55 V 4.8 mΩ
<b>R<sub>thJC</sub></b>	thermal resistance junction to case				0.7 K/W
<b>R<sub>thCH</sub></b>	thermal resistance case to heatsink			0.25	K/W
<b>P<sub>tot</sub></b>	total power dissipation	T <sub>C</sub> = 25°C			215 W
<b>I<sub>FSM</sub></b>	max. forward surge current	t = 10 ms; (50 Hz), sine; V <sub>R</sub> = 0 V	T <sub>VJ</sub> = 45°C		550 A
<b>C<sub>J</sub></b>	junction capacitance	V <sub>R</sub> = 24V f = 1 MHz	T <sub>VJ</sub> = 25°C	261	pF

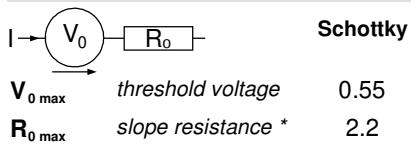
**Package TO-247**

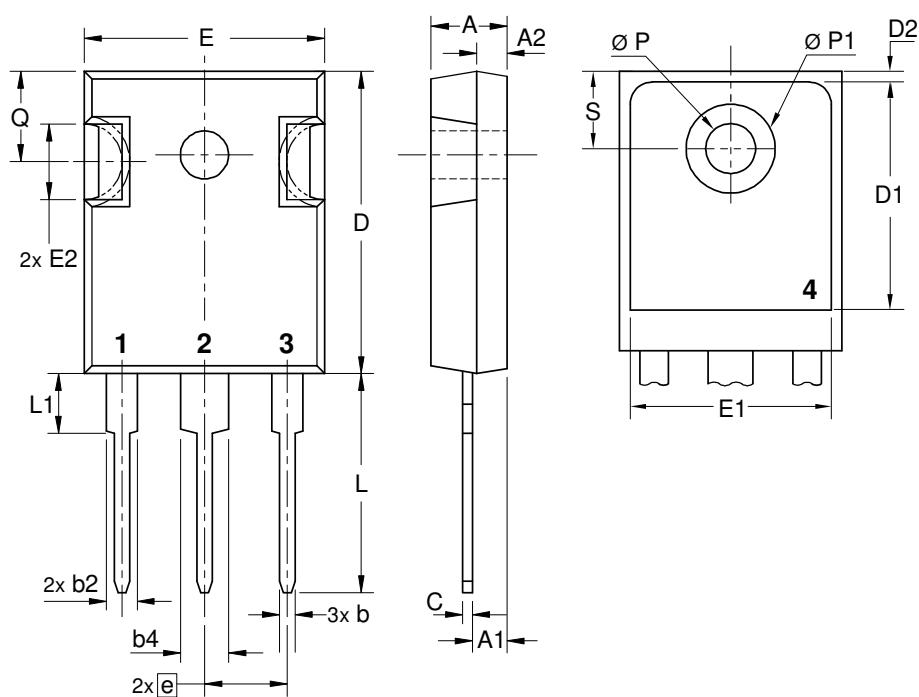
Symbol	Definition	Conditions	min.	typ.	max.	Unit
$I_{RMS}$	RMS current	per terminal <sup>1)</sup>			70	A
$T_{VJ}$	virtual junction temperature		-55		175	°C
$T_{op}$	operation temperature		-55		150	°C
$T_{stg}$	storage temperature		-55		150	°C
<b>Weight</b>				6		g
$M_d$	mounting torque		0.8		1.2	Nm
$F_c$	mounting force with clip		20		120	N

**Product Marking**

**Part description**

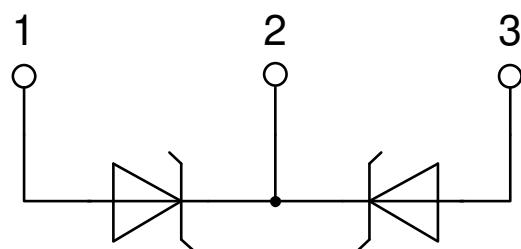
D = Diode  
S = Schottky Diode  
A = low VF  
70 = Current Rating [A]  
C = Common Cathode  
200 = Reverse Voltage [V]  
HB = TO-247AD (3)

Ordering	Ordering Number	Marking on Product	Delivery Mode	Quantity	Code No.
Standard	DSA70C200HB	DSA70C200HB	Tube	30	509195

**Equivalent Circuits for Simulation**
<sup>\* on die level</sup>
 $T_{VJ} = 175^\circ\text{C}$ 


**Outlines TO-247**


Sym.	Inches min. max.	Millimeter min. max.
A	0.185 0.209	4.70 5.30
A1	0.087 0.102	2.21 2.59
A2	0.059 0.098	1.50 2.49
D	0.819 0.845	20.79 21.45
E	0.610 0.640	15.48 16.24
E2	0.170 0.216	4.31 5.48
e	0.215 BSC	5.46 BSC
L	0.780 0.800	19.80 20.30
L1	- 0.177	- 4.49
Ø P	0.140 0.144	3.55 3.65
Q	0.212 0.244	5.38 6.19
S	0.242 BSC	6.14 BSC
b	0.039 0.055	0.99 1.40
b2	0.065 0.094	1.65 2.39
b4	0.102 0.135	2.59 3.43
c	0.015 0.035	0.38 0.89
D1	0.515 -	13.07 -
D2	0.020 0.053	0.51 1.35
E1	0.530 -	13.45 -
Ø P1	- 0.29	- 7.39



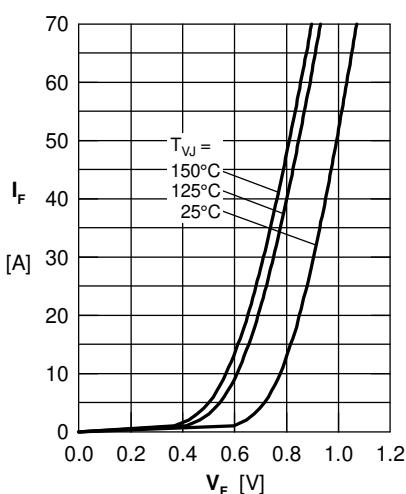
**Schottky**


Fig. 1 Maximum forward voltage drop characteristics

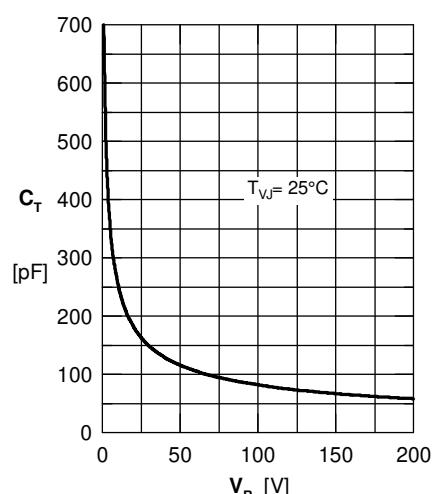


Fig. 3 Typ. junction capacitance  $C_T$  vs. reverse voltage  $V_R$

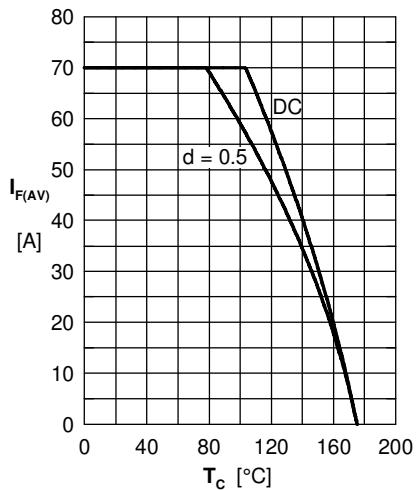


Fig. 4 Avg: forward current  $I_{F(AV)}$  vs. case temperature  $T_C$

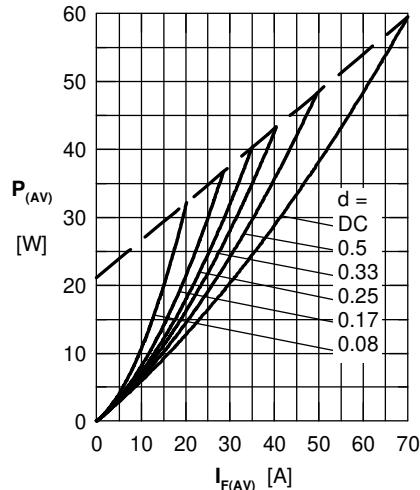


Fig. 5 Forward power loss characteristics

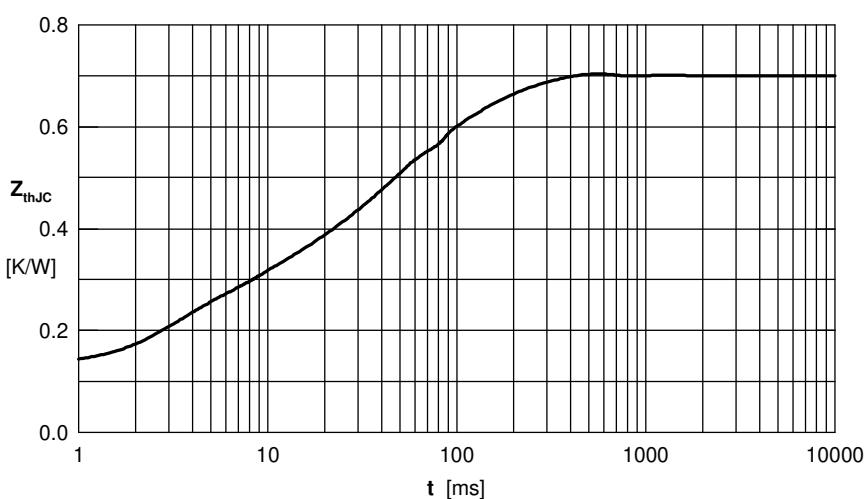


Fig. 6 Transient thermal impedance junction to case